

SPECIFICATION

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SPEC. NO.:	PS-520	006-XXXXX-XXX	REVISION:	A
PRODUCT N	NAME:	0.50mm PITCH BTB	D/R CONN SMT S/T T	YPE
PRODUCT N	NO:	52006,52007		

PREPARED:

CHECKED:

APPROVED:

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baieh,fu yu

DATE:
2020/09/15

DATE:
2020/09/15

TITLE: 0.50 mm PITCH BTB D/R CONN SMT S/T TYPE RELEASE DATE: 2020/09/15 REVISION: A ECN NO. ECN -000342 PAGE 2 OF 9 1 REVISION HISTORY. 3 2 SCOPE 4 3 APPLICABLE DOCUMENTS 4 4 REQUIREMENTS 4 5 PERFORMANCE 5 6 INFRARED REFLOW CONDITION 7 7 CONNECTOR USAGE 8 8 PRODUCT QUALIFICATION AND TEST SEQUENCE 9
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Revision History Revision Description Approved Approved Reconverse Approved Approved	ECN No: ECN-000342 PAGE: 3 OF 9 Pription Approved Date	1CES		Ac	es P/N: 52006,5200	7 series	
Revision History Rev. ECN# Revision Description Approved Date	ription Approved Date	TLE: 0.	50 mm PITCH B	TB D/R CONN	SMT S/T TYPE		
Rev. ECN# Revision Description Approved Date	Rong,Li Ping 2020/09/15	ASE DATE:	2020/09/15	REVISION: A	ECN No: ECN-0	000342 F	PAGE: 3 OF 9
Rev. ECN# Revision Description Approved Date	Rong,Li Ping 2020/09/15	Revision	on History				
A ECN-000342 NEW SPEC Rong, Li Ping 2020/09/15	Rong,Li Ping 2020/09/15			Revis	sion Description	Approved	Date
				NEW SPEC			



TITLE: 0.50 mm PITCH BTB D/R CONN SMT S/T TYPE

2 SCOPE

This specification covers performance, tests and quality requirements for 0.50mm pitch BTB connector. ACES P/N: 52006,52007 Series.

3 APPLICABLE DOCUMENTS

EIA-364 ELECTRONICS INDUSTRIES ASSOCIATION

4 REQUIREMENTS

- 4.1 Design and Construction
 - 4.1.1 Product shall be of design, construction and physical dimensions specified on applicable product drawing.
 - 4.1.2 All materials conform to R.o.H.S. and the standard depends on TQ-WI-140101.
- 4.2 Materials and Finish
 - 4.2.1 Contact: High performance copper alloy
 - Finish: (a) Contact Area: Refer to the drawing
 - (b) Under plate: Refer to the drawing
 - 4.1.2 Housing: Thermoplastic High Temp., UL94V-0
- 4.3 Ratings
 - 4.3.1 Working Voltage Less than 36 Volts AC(per pin)
 - 4.3.2 Voltage: 60 Volts AC (per pin)
 - 4.3.3 Current: 0.5 Amperes (per pin)
 - 4.3.4 Operating Temperature : -40°C to +80°C



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5 Performance

5.1. Test Requirements and Procedures Summary

Item	Requirement	Standard				
Examination of Product	Product shall meet requirements of applicable product drawing and specification.	Visual, dimensional and functional per applicable quality inspection plan.				
	ELECTRICAL	рин.				
Item	Requirement	Standard				
Low Level Contact Resistance	60 m Ω Max.(Initial)per contact 60 m Ω Max.(Final)	Mate connectors, measure by dry circuit, 20mV Max., 100mA Max. (EIA-364-23)				
Insulation Resistance	500 M Ω Min. (Initial) 100 M Ω Min. (Final)	Unmated connectors, apply 500 V DC between adjacent terminals. (EIA-364-21)				
Dielectric Withstanding Voltage	No discharge, flashover or breakdown. Current leakage: 1 mA max	250 VAC Min. at sea level for 1 minute. Test between adjacent contacts of unmated connectors. (EIA-364-20)				
Temperature rise	30°C Max. Change allowed	Mate connector: measure the temperature rise at rated current until temperature stable. The ambient condition is still air at 25°C (EIA-364-70,METHOD1,CONDITION1				
	MECHANICAL					
Item	Requirement	Standard				
Durability	30 cycles.	The sample should be mounted in the tester and fully mated and unmated the number of cycles specified at the rate of 25.4 ± 3mm/min. (EIA-364-09)				
	Unit: Kg	Operation Speed:				
Mating / Unmating Forces	Pins Mating Force(Max) Unmating Force(Min) Initial Final Initial Final 60~80 8.0 7.0 0.7 0.5 100~120 9.0 8.0 0.8 0.6	25.4 ± 3 mm/minute. Measure the force required to mate/Unmate connector. (EIA-364-13)				



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Terminal / Housing Retention Force	0.2kgf MIN.	speed rate of 2	Apply axial pull out force at the speed rate of 25.4 ± 3 mm/minute. On the terminal assembled in the housing.				
Vibration	1 μs Max.	The electrical lobe 100 mA may contacts. Subjet harmonic motion of 0.76mm (1.5) total excursion) between the lime The entire frequestall be travers a minute. This applied for 2 how mutually perper (EIA-364-28 Co.)	ect to a simple In having amplitude Image: Amm maximum Image: Amm maxi				
Shock (Mechanical)	1 μs Max.	pulses of 11 mi Three shocks ir shall be applied mutually perper test specimen (electrical load of	alue) half-sine shock diseconds duration. In each direction along the three andicular axes of the 18 shocks). The condition shall be am for all contacts.				
	ENVIRONM	IENTAL					
Item	Requiremer	nt Sta	ndard				
Resistance to Reflow Soldering Heat	See Product Qualificatio	Pre Heat: 150° 60~120sec. Heat: 230°C M	in., 40sec Min.				
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ltem	Requirement	Standard
Resistance to Reflow Soldering Heat	See Product Qualification and Test Sequence Group 9 (Lead Free)	Pre Heat: 150°C~180°C, 60~120sec. Heat: 230°C Min., 40sec Min. Peak Temp.: 260°C Max, 10sec Max. Reflow number cycle: 2 times
Thermal Shock	See Product Qualification and Test Sequence Group 4	Mate module and subject to follow condition for 5 cycles. 1 cycles: -40 +0/-3 ℃, 30 minutes +85 +3/-0 ℃, 30 minutes (EIA-364-32, test condition A)
Humidity	See Product Qualification and Test Sequence Group 4	Mated Connector 40°C, 75∼80% RH, Reefer to Method II. (EIA-364-31, Test condition A)



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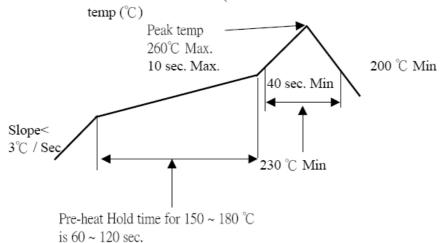
Temperature life	See Product Qualification and	Subject mated connectors to temperature life at 85°C for 96 hours. Measure Signal. (EIA-364-17, Test condition A)
Salt Spray	See Product Qualification and Test Sequence Group 6	Subject mated/unmated connectors to 5% salt-solution concentration, 35°C for 24 hours. (EIA-364-26,Test condition B)
Solder ability	Solder able area shall have	And then into solder bath, Temperature at 260 ±5°ℂ, for 4-5 sec. (EIA-364-52)

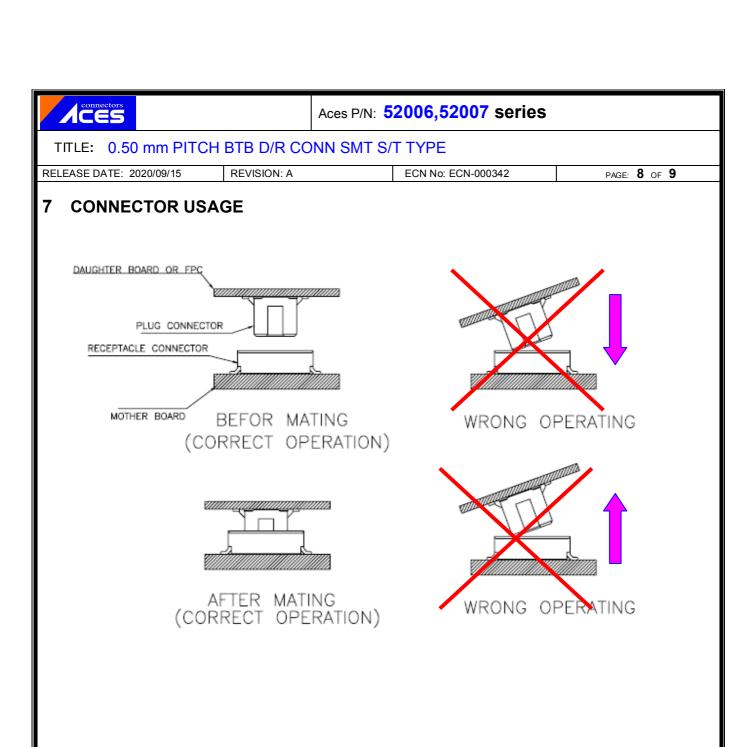
Note. Flowing Mixed Gas shell be conduct by customer request.

6 INFRARED REFLOW CONDITION

6.1. Lead-free Process

TEMPERATURE CONDITION GRAPH (TEMPERATURE ON BOARD PATTERN SIDE)





connectors
CES

TITLE: 0.50 mm PITCH BTB D/R CONN SMT S/T TYPE

8 PRODUCT QUALIFICATION AND TEST SEQUENCE

		Test Group								
Test or Examination	1	2	3	4	5	6	7	8	9	
				T	est Se	quenc	e			
Examination of Product				1 . 7	1 \ 6	1 \ 4			1	
Low Level Contact Resistance		1 \ 5	1 \ 4	2 \ 10	2 \ 9	2 \ 5			3	
Insulation Resistance				3 . 9	3、8					
Dielectric Withstanding Voltage				4 · 8	4 · 7					
Mating / Unmating Forces		2 · 4								
Temperature rise	1									
Durability		3								
Vibration			2							
Shock (Mechanical)			3							
Thermal Shock				5						
Humidity				6						
Temperature life					5					
Salt Spray						3				
Solder ability							1			
Terminal / Housing Retention Force								1		
Resistance to Soldering Heat									2	
Sample Size	2	4	4	4	4	4	2	4	4	